## M1325 Surface Mount Crystal 3.2 x 5 x 0.8 mm



## Ordering Information Features: 00.0000 Ultra-Miniature Size M1325 XX MHz М Tape & Reel Leadless Ceramic Package - Seam Sealed Product Series **Operating Temperature** Applications: 1: 0°C to +70°C 3: -10°C to +60°C Handheld Electronic Devices 2: -40°C to +85°C 6: -20°C to +70°C PDA, GPS, MP3 Tolerance @ +25°C J: ±30 ppm (std) \*D: ±10 ppm Portable Instruments E: ±15 ppm M: ±50 ppm G: ±20 ppm P: ±100 ppm H: ±25 ppm Stability \*D:±10 ppm J:±30 ppm E: ±15 ppm M:±50 ppm (std) G: ±20 ppm P: ±100 ppm H: ±25 ppm \_oad Capacitance Blank: 18 pF (std) S: Series Resonant XX: Customer Specified 8 pF to 32 pF Frequency (customer specified) \*Consult Factory M1325Sxxx - Contact factory for data sheet. SUGGESTED SOLDER PAD LAYOUT 0.091 ±0.004 0.197 ±0.008 $(2.30 \pm 0.10)$ -0.138 (3.50) (TOP VIEW) $(5.00 \pm 0.20)$ -0.047 (1.20) TYP -0.063 (1.60) CONNECTIONS -0.047 (1.20) TYP + + 0.126 ±0.008 0.081 (2.05) (3.20 ±0.20) + + 0.033 (0.85) TYP 0.053 (1.35) (2 & 4 connected thru metal cover and may $0.031 \pm 0.004$ All dimensions be connected to ground) $(0.80 \pm 0.10)$ in inches (mm). Parameter Symbol Min. Max. Units Conditions Тур. **Frequency Range** F 12 54 MHz F/F **Frequency Tolerance** See Ordering Information ppm +25°C Frequency Stability F/F See Ordering Information Over Operating Temperature ppm See Ordering Information **Operating Temperature** Topr °C Specification Storage Temperature T<sub>stg</sub> -55 +125 °C Fa ±5 +25°C Aging ppm/yr See Ordering Information Load Capacitance $C_L$ Shunt Capacitance $C_0$ 7 рF ectrical ESR **Fundamental AT-Cut Frequencies** 12.000000 to 19.999999 MHz 80 Ohms All ī 20.000000 to 29.999999 MHz 70 Ohms All 30.000000 to 54.000000 MHz Ohms All 50 10 50 100 **Drive Level** D uW Insulation Resistance 500 Megohms 100 VDC $I_R$ Internal Specification 168 hrs. at +55°C Aging **Physical Dimensions** MIL-STD-883, Method 2016 nmenta Shock MIL-STD-202, Method 213 Condition C 100 a Vibration MIL-STD-202, Methods 201 & 204 10 g from 10-2000 Hz **Thermal Cycle** MIL-STD-883, Method 1010, Condition B -55°C to +125°C nviror **Gross Leak** MIL-STD-202, Method 112 30 sec. Immersion Fine Leak MIL-STD-202, Method 112 1 x 10<sup>-8</sup> atmcc/sec. min. ш Max Soldering Conditions See solder profile, Figure 1 **Resistance to Solvents** MIL-STD-883, Method 2015 Three 1 minute soaks



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## **MtronPTI Lead Free Solder Profile**



